

T530D477M2R5AHE006

General Information

MSL

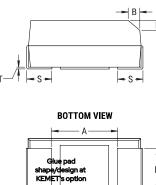
T530, Tantalum, Polymer Tantalum, Multi-Anode, 470 uF, 20%, 2.5 VDC, SMD, Polymer, Molded, Multiple Anodes, Low ESR, 6 mOhms, 7343, 3.1 mm, 1.3 mm

CATHODE (-) END VIEW

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P Termination cutout at KEMET's option, either end

ANODE (+) END VIEW



SIDE VIEW

T530 Series Dielectric Polymer Tantalum Style SMD Chip SMD, Polymer, Molded, Multiple Anodes, Low ESR Description Features Low ESR RoHS No Prop 65 WARNING: Cancer and reproductive harm https://www.p65warnings.ca.gov SCIP Number b064b03e-bd75-42af-b342-1fe 94dec2340 Termination Tin Lead (SnPb) AEC-Q200 No Typical Component Weight 307.51 mg Shelf Life 52 Weeks

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Dimensions	
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
Н	2.8mm +/-0.3mm
т	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
Α	3.8mm MIN
В	0.5mm +/-0.15mm
Р	0.9mm REF
R	1mm REF
х	0.1mm +/-0.1mm REF

Click here for the 3D model.

Packaging Specifications	
Packaging	T&R, 178mm
Packaging Quantity	500

Specifications	
Capacitance	470 uF
Tolerance	20%
Voltage DC	2.5 VDC (105C), 1.68 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	105°C
Life	2000 Hrs (125C)
Humidity	60C, 90% RH, 1000 Hours, No Load
Dissipation Factor	8% 120Hz 25C
Failure Rate	N/A
ESR	6 mOhms (100kHz 25C)
Ripple Current	6500 mA (rms, 100kHz 45C), 4550 mA (rms, 85C), 1625 mA (rms, 125C)
Leakage Current	117.5 uA (5min 25°C)

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

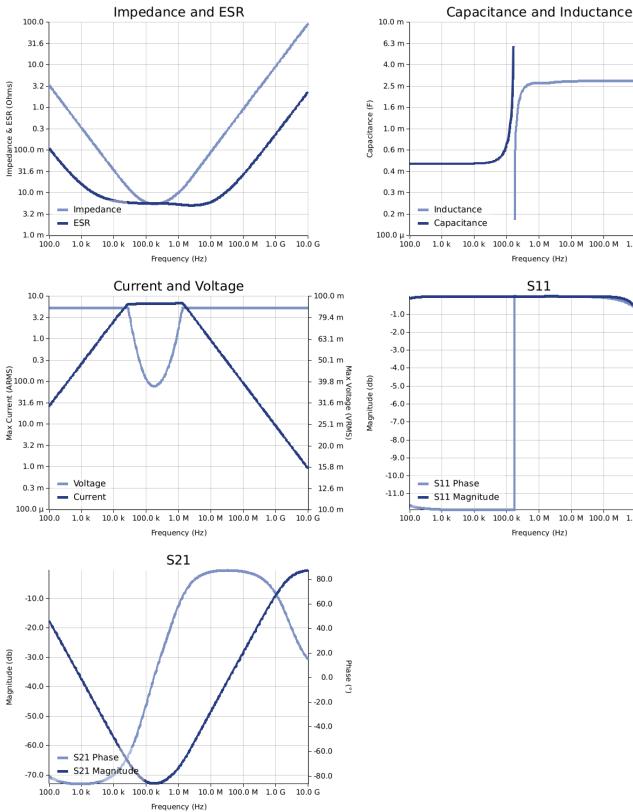


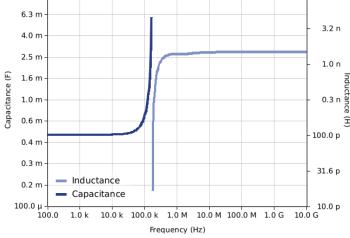
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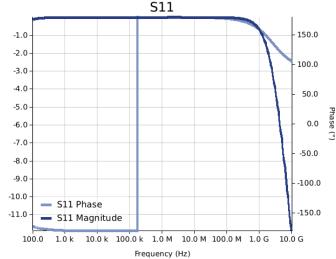
Simulations

For the complete simulation environment please visit K-SIM.





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These are simulations.

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.

- The ESR used for hipple klipple current younge vs. requericy plots is the ESR at an bient temperature.
 The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
 The effects shown herein are based on measured data from a multiple part sample of the parts in question.
 Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
 The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages are not combined with voltages.
- generated at any other harmonics.
 Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

If you have any questions please contact K-SIM.